<u>MOSFET</u> – Power, Dual N-Channel 60 V, 44 mΩ, 20 A

Features

- Small Footprint (5x6 mm) for Compact Designs
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- 175°C Operating Temperature
- NVMFD5485NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- This is a Pb–Free Device

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

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Parar	neter		Symbol	Value	Unit
Drain-to-Source Voltag	е		V _{DSS}	60	V
Gate-to-Source Voltage	Gate-to-Source Voltage		V _{GS}	±20	V
Continuous Drain		T _C = 25°C	١ _D	19.5	A
Current R _{θJC} (Notes 1, 2, 4)	Steady	T _C = 100°C		13.8	NE
Power Dissipation	State	T _C = 25°C	PD	38.5	W
$R_{\theta JC}$ (Notes 1, 2)		T _C = 100°C		19.2	C/
Continuous Drain		T _A = 25°C	Ð	5.3	A
Current R _{θJA} (Notes 1, 3 & 4)	Steady	T _A = 100°C	$^{\circ}C$	3.8	E
Power Dissipation	State	T _A = 25°C	PD	2.9	W
R _{θJA} (Notes 1 & 3)		T _A = 100°C	D'N	1.4	
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	СІрм	113	А
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to 175	°C
Source Current (Body D	liode)	RE	۱ _S	37	Α
Single Pulse Drain-to-S			E _{AS}	31	mJ
Energy (T _J = 25°C, V _{DD} $I_{L(pk)}$ = 25 A, L = 0.1 mH	= 50 v, v I, R _G = 25	GS = 10 V, $\Omega)$			
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 2)	$R_{\theta JC}$	3.9	°C/W
Junction-to-Ambient - Steady State (Note 3)	$R_{\theta JA}$	52	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted to an ideal (infinite) heat sink.

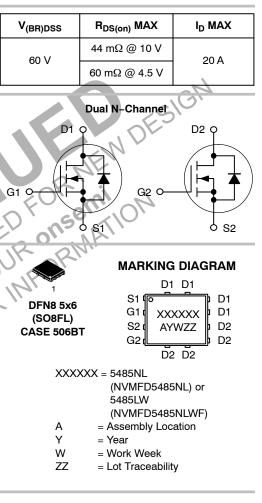
3. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

4. Maximum current for pulses as long as 1 second are higher but are dependent on pulse duration and duty cycle.



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ORDERING INFORMATION

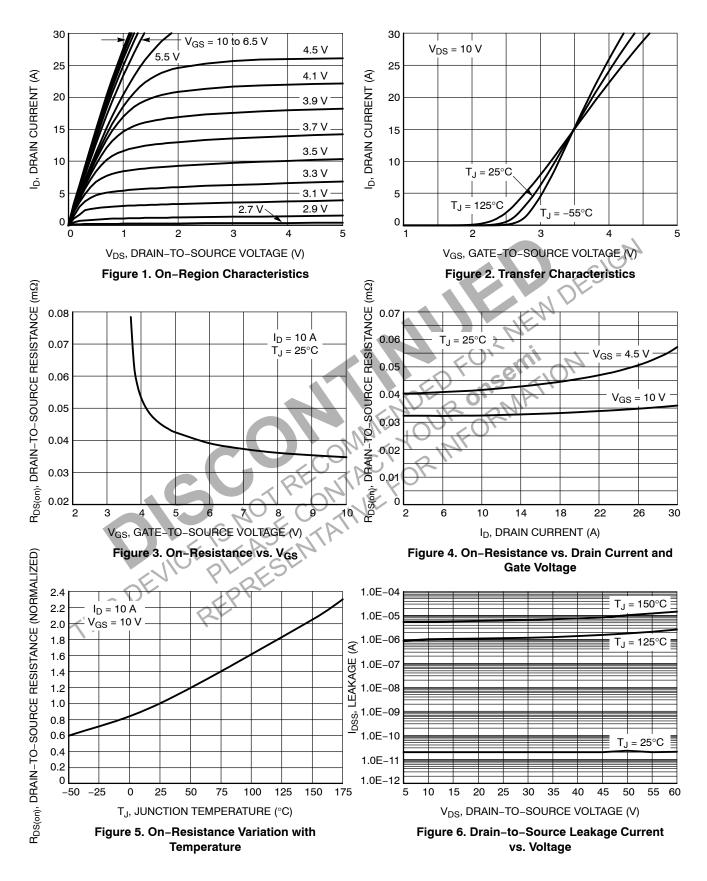
Device	Package	Shipping [†]
NVMFD5485NLT1G	DFN8 (Pb-Free)	1500/ Tape & Reel
NVMFD5485NLT3G	DFN8 (Pb-Free)	5000/ Tape & Reel
NVMFD5485NLWFT1G	DFN8 (Pb-Free)	1500/ Tape & Reel
NVMFD5485NLWFT3G	DFN8 (Pb-Free)	5000/ Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

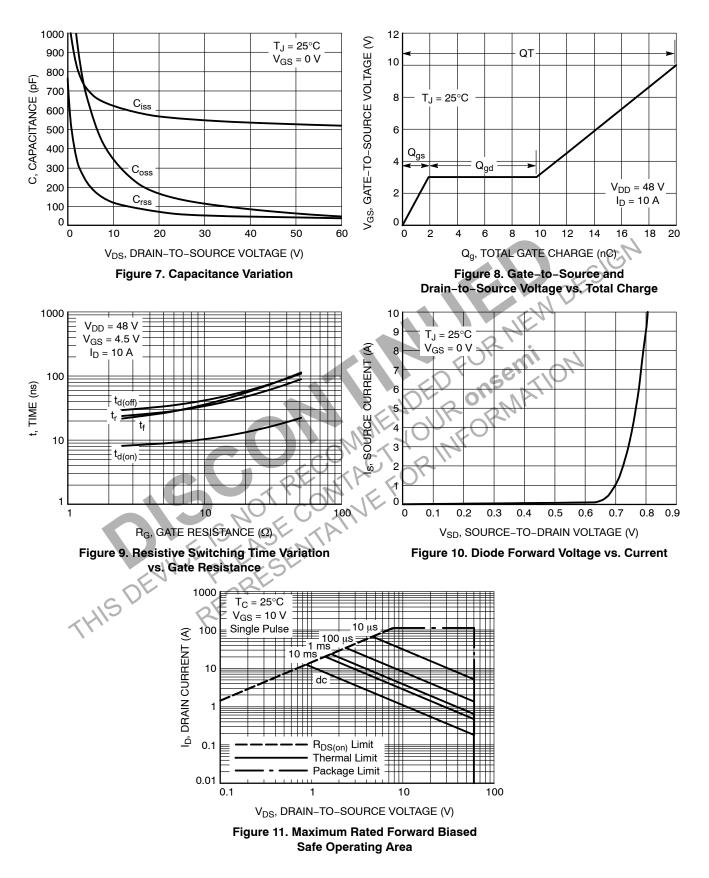
Parameter	Symbol	Test Conditi	on	Min	Тур	Max	Unit
OFF CHARACTERISTICS	-						-
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_D = 2$	250 μΑ	60	ĺ		V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	Reference to 25°C I _D = 250 μA			67		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 60 V	$T_{J} = 25^{\circ}C$ $T_{J} = 125^{\circ}C$			1.0 10	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} =	= ±20 V			±100	nA
ON CHARACTERISTICS (Note 5)					L		
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D =	250 μA	1.5		2.5	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J	Reference to 25°C $I_D = 250 \mu A$			-4.86		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D =	V_{GS} = 10 V, I _D = 15 A V_{GS} = 4.5 V, I _D = 10 A		33	44	mΩ
		V_{GS} = 4.5 V, I _D =			42	60	2
CHARGES AND CAPACITANCES						<u>c10.</u>	-
Input Capacitance	C _{iss}				560		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 25 V			126		
Reverse Transfer Capacitance	C _{rss}	•			58		
Total Gate Charge	Q _{G(TOT)}			2	20		nC
Threshold Gate Charge	Q _{G(TH)}	V_{GS} = 10 V, V_{DS}	= 48 V,	D. C	0.52		
Gate-to-Source Charge	Q _{GS}	I _D = 10 A		Ser	1.9		1
Gate-to-Drain Charge	Q _{GD}		OF C		7.9		1
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = 4.5 \text{ V}, V_{DS}$ $I_D = 10 \text{ A}$	= 48 V,	Skin	11.5		nC
SWITCHING CHARACTERISTICS (No	ote 6)		10,74				
Turn-On Delay Time	t _{d(on)}		R		9.5		ns
Rise Time	t _r	$V_{GS} = 4.5 V, V_{DS}$	= 48 V,		26.6		1
Turn-Off Delay Time	t _{d (off)}	$V_D = 10 \text{ A, } R_G = 2.5 \Omega$			27.8		1
Fall Time					23.7		
DRAIN-SOURCE DIODE CHARACTE	RISTICS	KAK.					
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.93	1.2	V
	1-25	I _S = 15 A	T _J = 125°C		0.83		1
Reverse Recovery Time	T RR				28.9		ns
Charge Time	ta	V_{GS} = 0 V, d_{IS}/d_t = 100 A/µs, I_S = 10 A			23.2		1
Discharge Time	t _b	$I_{\rm S} = 10$ A		5.6		1	
Reverse Recovery Charge	Q _{RR}			35.5		nC	
PACKAGE PARASITIC VALUES	-						
Source Inductance	L _S				0.93		nH
Drain Inductance	L _D	T _A = 25°C			0.005		
Gate Inductance	L _G				1.84		
Gate Resistance	R _G				12		Ω

 $\begin{array}{ll} \text{5. Pulse Test: pulse width = 300 } \mu\text{s, duty cycle} \leq 2\%. \\ \text{6. Switching characteristics are independent of operating junction temperatures.} \end{array}$

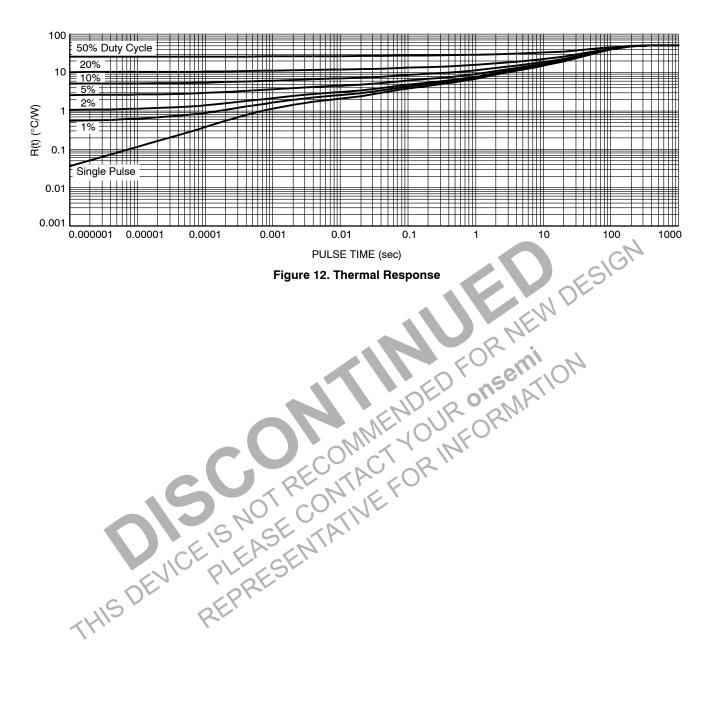
TYPICAL CHARACTERISTICS



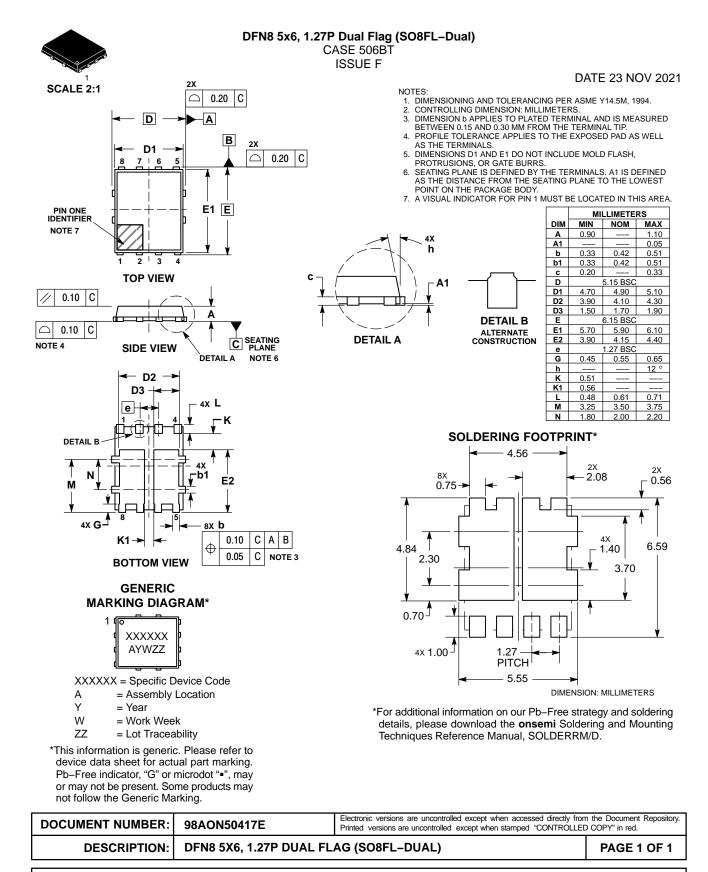
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



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